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Silicon PNP Triple Diffused

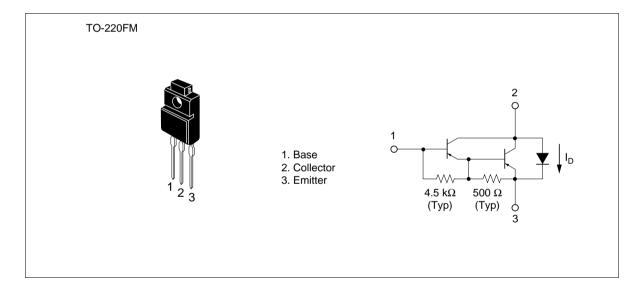


ADE-208-869 (Z) 1st. Edition September 2000

Application

Low frequency power amplifier

Outline



Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

Item	Symbol	Ratings	Unit
Collector to base voltage	V _{CBO}	-60	V
Collector to emitter voltage	V _{CEO}	-60	V
Emitter to base voltage	V _{EBO}	-7	V
Collector current	Ι _c	-4	А
Collector peak current	I _{C(peak)}	-8	A
Collector power dissipation	Pc	2	W
	Pc*1	25	
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C
C to E diode forward current	۱ ₀ *1	4	А

Note: 1. Value at $T_c = 25^{\circ}C$.

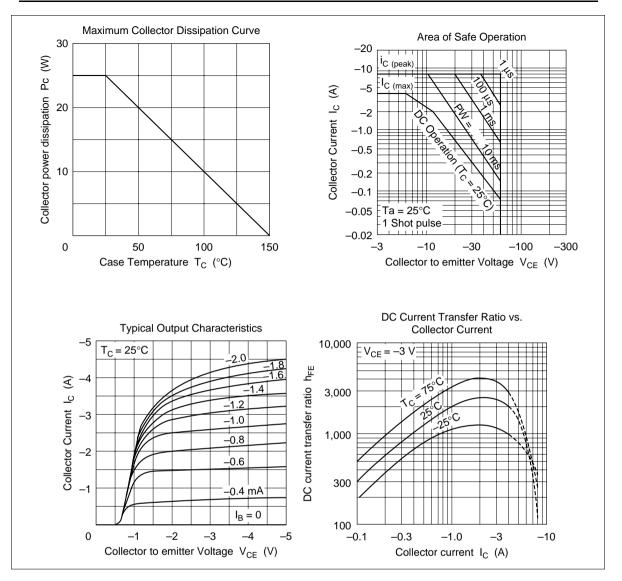
Electrical Characteristics (Ta = 25°C)

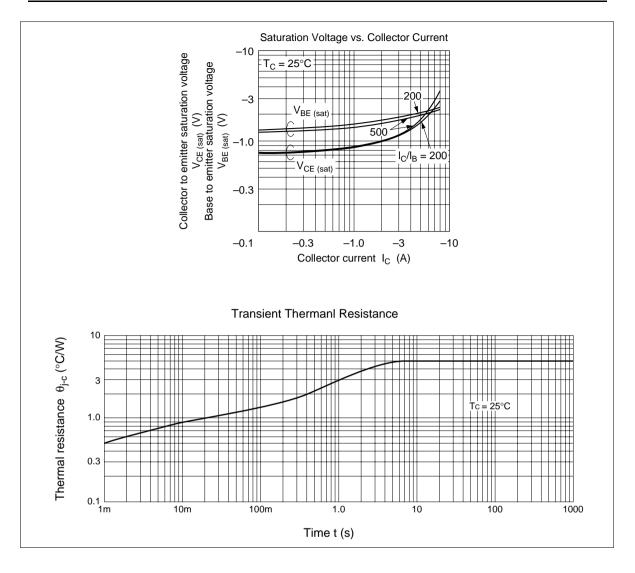
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{\rm (BR)CBO}$	-60	_		V	$I_{c} = -0.1 \text{ mA}, I_{E} = 0$
Collector to emitter breakdown voltage	$V_{\rm (BR)CEO}$	-60	_	_	V	$I_c = -25 \text{ mA}, R_{BE} = \infty$
Emitter to base breakdown voltage	$V_{(\text{BR})\text{EBO}}$	-7	_	_	V	$I_{\rm E} = -50$ mA, $I_{\rm C} = 0$
Collector cutoff current	I _{CBO}		—	-10	μΑ	$V_{\rm CB} = -50 \text{ V}, \ I_{\rm E} = 0$
	I _{CEO}		—	-10	_	$V_{ce} = -50$ V, $R_{be} = \infty$
DC current transfer ratio	h _{FE}	1000	—	20000		$V_{ce} = -3 \text{ V}, \text{ I}_{c} = -2 \text{ A}^{*1}$
Collector to emitter saturation	$V_{\text{CE(sat)1}}$	_	_	-1.5	V	$I_{\rm C} = -2$ A, $I_{\rm B} = -4$ mA ^{*1}
voltage	V _{CE(sat)2}	_	_	-3.0	_	$I_{\rm c} = -4$ A, $I_{\rm B} = -40$ mA ^{*1}
Base to emitter saturation	$V_{\text{BE(sat)1}}$		—	-2.0	V	$I_{\rm C} = -2$ A, $I_{\rm B} = -4$ mA ^{*1}
voltage	$V_{\text{BE(sat)2}}$		_	-3.5	_	$I_{\rm c} = -4$ A, $I_{\rm B} = -40$ mA ^{*1}
C to E diode forward voltage	V _D		_	3.0	V	$I_{\rm D} = 4 \ {\rm A}^{*1}$

Note: 1. Pulse test.

See switching characteristic curve of 2SB1101.

RENESAS





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Hitachi, Ltd.

Semiconductor & IC Div. Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100, Japan Tel: Tokyo (03) 3270-2111 Fax: (03) 3270-5109

For further information write to:

Hitachi America, Ltd. Semiconductor & IC Div. 2000 Sierra Point Parkway Brisbane, CA. 94005-1835 U S A Tel: 415-589-8300 Fax: 415-583-4207 Hitachi Europe GmbH Electronic Components Group Continental Europe Dornacher Straße 3 D-85622 Feldkirchen München Tel: 089-9 91 80-0 Fax: 089-9 29 30 00 Hitachi Europe Ltd. Electronic Components Div. Northern Europe Headquarters Whitebrook Park Lower Cookham Road Maidenhead Berkshire SL6 8YA United Kingdom Tel: 0628-585000 Fax: 0628-778322 Hitachi Asia Pte. Ltd. 16 Collyer Quay #20-00 Hitachi Tower Singapore 0104 Tel: 535-2100 Fax: 535-1533

Hitachi Asia (Hong Kong) Ltd. Unit 706, North Tower, World Finance Centre, Harbour City, Canton Road Tsim Sha Tsui, Kowloon Hong Kong Tel: 27359218 Fax: 27306071



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